EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4	("20030062608"|"6307272").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 19:52
L2	11064	(257/78$1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/23 20:00
L3	5683	(257/79$1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/23 20:00
L4	1080	L2 and L3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L5	13	L4 and (powre near2 MOSFET IGBT)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L6	31	("3781613"| "3784884"| "4346396" | "4546374"| "4617585"| "4649637" | "4827329"| "4950427"| "5038200" | "5075758"| "5113240"| "5173762" | "5229918"| "5291178"| "5309027" | "5309460"| "5434449"| "5444294" | "5557842"| "5563441"| "5587608" | "5767567"| "5814884"| "5917704" | "5977630"| "6078098"| "6114750" | "6144093"| "6297552"| "6476481").PN. OR ("6667547"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L7	16	L4 and (power near2 MOSFET IGBT)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00

L8	13	L5 and L7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L9	16	L5 or L7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L10	2	"20040262720".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON.	2006/02/23 20:00
L11	17538	(powre near2 MOSFET IGBT)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L12	5231	source with lead with (ribbon plate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L13	35	L11 and L12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L14	5390	source with lead with (ribbon plate strap)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L15	48	L11 and L14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 20:00
L16	7	("4996583" | "5103290" | "5105536" | "5648682" | "6268651" | "6566164" | "6650004").PN. OR ("6812554"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00

L17	38	("4189342" | "4935803" | "4942452" | "4987478" | "5041902" | "5218231" | "5266834" | "5278446" | "5328870" | "5455462" | "5477160" | "5544412" | "5663597" | "5665996" | "5701034" | "5708567" | "5722161" | "5731709" | "5767527" | "5807768" | "5814884" | "5854511" | "5866949" | "5877043" | "6028354" | "6040626" | "6127727" | "6144093" | "6187611" | "6223429" | "6229204" | "6242283" | "6249041" | "6252300" | "6255672" | "6256200" | "6306680" | "6309916").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L18	1	resilient adj ribbon adj strap	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L19	232	ribbon adj strap	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L20	195	resilient adj ribbon	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L21	8	L20 and "257"/$.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L22	2	L19 and "257"/$.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L23	7	("5604376" | "5708300" | "5841192" | "6046501" | "6320251" | "6329711").PN. OR ("6633080"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/23 20:00
L24	4039	(257/666).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/23 20:57
L25	2350	(257/676).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/23 20:57
L26	50	24 and control with electrode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 21:31

L27	45	25 and control with electrode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 21:01
L28	28	27 not 26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/23 21:01
L29	121	((sealing molding encapsulant) and lead and (pad electrode contact) and control and (IC chip integrated near1 circuit semiconductor silicon wafer)).clm.	US-PGPUB	OR	ON	2006/02/23 21:32